



www.aopled.com

American Opto Plus LED Corp.
0.30" Case mold Type LED Display
AOP A302LE G/W
AOP C302LE G/W

● **EDIT HISTORY**

Version A: May. 06, 2014

Preliminary Spec.

Manufacture	Examination	Approving



www.aopled.com

American Opto Plus LED Corp.
0.30" Case mold Type LED Display
AOP A302LE G/W
AOP C302LE G/W

● **FEATURES**

- 0.3 inch (7.62 mm) Digit Height.
- Low current operation.
- Case mold type.
- Gray face, White segment.
- RoHS compliant, Pb Free.

● **DESCRIPTION**

The A302LE G/W & C302LE G/W is a 0.3 inch (7.62 mm) height dual digits display. This device utilizes Super Bright Red LED chip which are made from AlGaInP on a transparent GaAs substrate. The display has Gray face, White segment.

● **DEVICE**

PART NO Super Bright Red	DESCRIPTION
A302LE G/W	Common Anode
C302LE G/W	Common Cathode

RoHS Compliance



Pb free.





www.aopled.com

American Opto Plus LED Corp.

0.30" Case mold Type LED Display

AOP A302LE G/W

AOP C302LE G/W

● LE: SUPER BRIGHT RED (AlGaInP/GaAs)

ABSOLUTE MAXIMUM RATING AT Ta=25°C

Parameter	Symbol	Super Bright Red	Unit
Power dissipation per dice	P _{AD}	70	mW
Derating liner from 25°C per dice	-	0.33	mA / °C
Continuous forward current per dice	I _{AF}	25	mA
Peak current per dice (duty cycle 1/10, 1kHz)	I _{PF}	90	mA
Reverse voltage per dice	V _R	5	V
Operating temperature	T _{OPR}	-25 to +85	°C
Storage temperature	T _{STG}	-25 to +85	°C

ELECTRICAL - OPTICAL CHARACTERISTICS AT Ta=25°C

Characteristic	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward voltage	V _F	I _F =20mA	-	2.0	2.6	V
Reverse current	I _R	V _R =5V	-	-	10	μA
Peak wavelength	λ _P	I _F =20mA	-	632	-	nm
Dominant wavelength	λ _D	I _F =20mA	619	624	629	nm
Luminous intensity	I _V	I _F =20mA	-	40	-	mcd
Spectral radiation bandwidth	Δλ	I _F =20mA	-	20	-	nm



www.aopled.com

American Opto Plus LED Corp.

0.30" Case mold Type LED Display

AOP A302LE G/W

AOP C302LE G/W

● LE: SUPER BRIGHT RED (AlGaInP/GaAs) CURVE

Typical Electro-optical Characteristic Curves
(25 °C Free Air Temperature Unless Otherwise Specified)

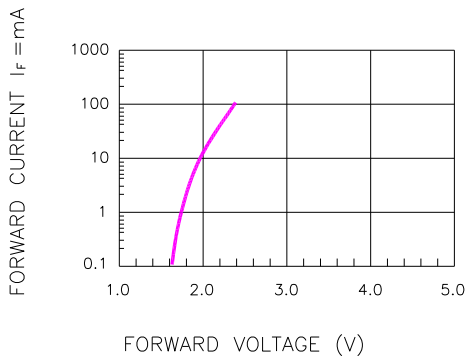


Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE

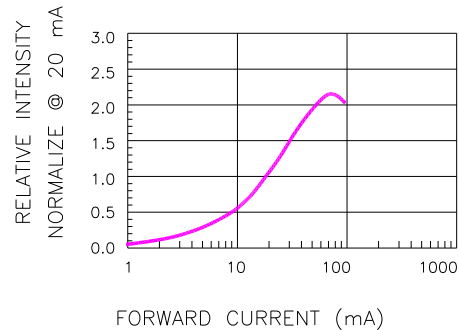


Fig.2 RELATIVE INTENSITY VS. FORWARD CURRENT

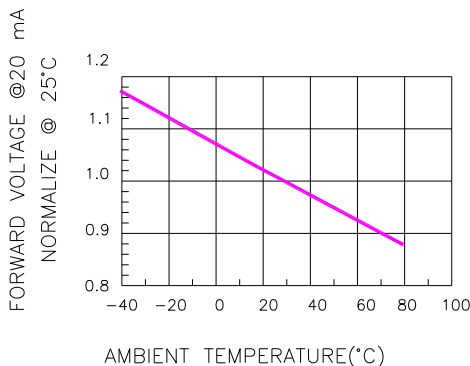


Fig.3 FORWARD VOLTAGE VS. TEMPERATURE

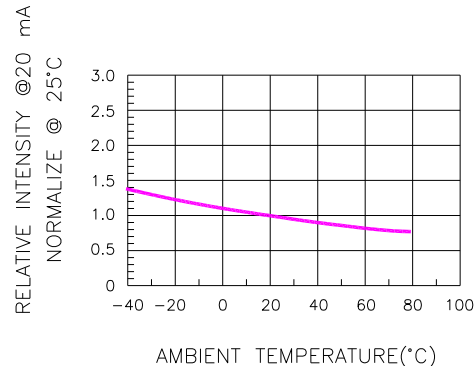


Fig.4 RELATIVE INTENSITY VS. TEMPERATURE

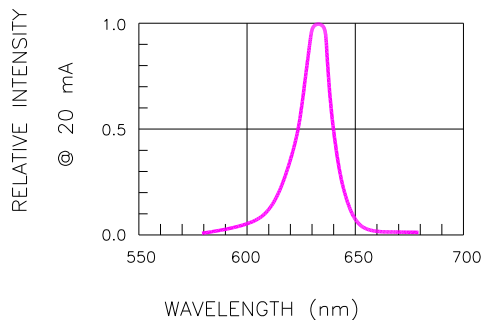


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

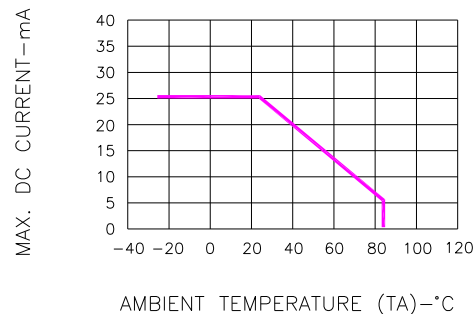


Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE



www.aopled.com

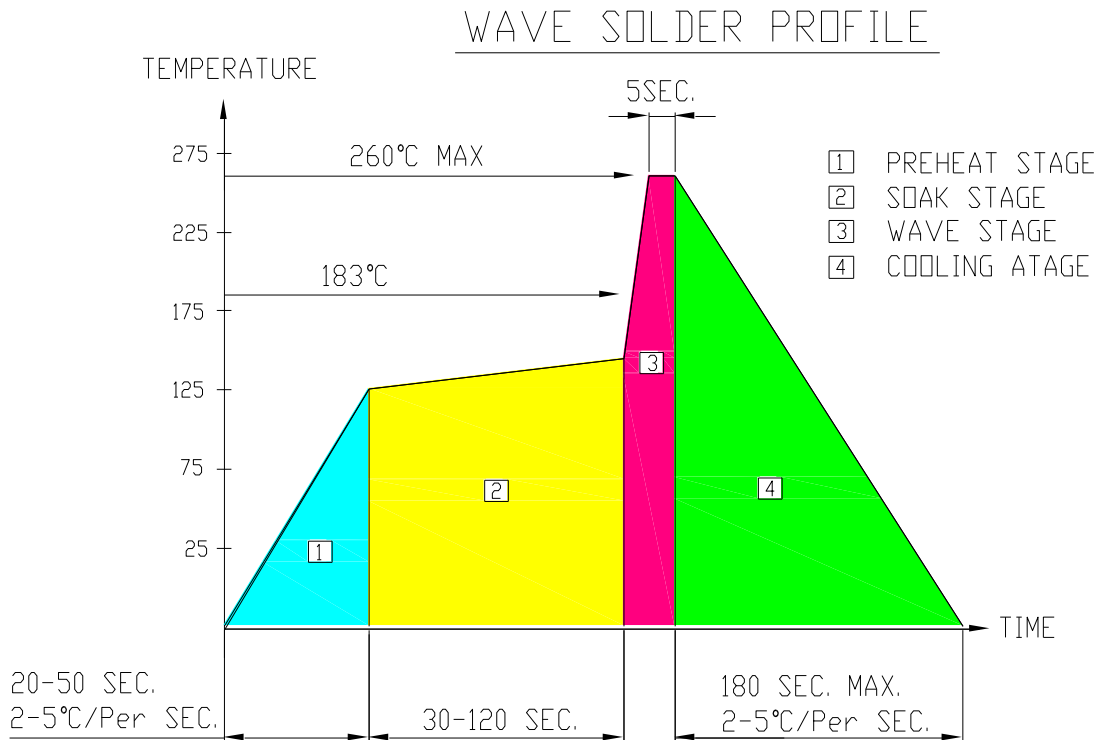
American Opto Plus LED Corp.

0.30" Case mold Type LED Display

AOP A302LE G/W

AOP C302LE G/W

● RECOMMEND SOLDERING PROFILE



● Note:

- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- Peak wave soldering temperature between 245°C ~ 225°C for 3 sec (5 sec max)
- No more than one wave soldering pass

● SOLDERING IRON

Basic spec is ≤ 4 sec when 260°C. If temperature is higher, time should be shorter (+10°C → 1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

● REWORK

Customer must finish rework within ≤ 3 sec under 350°C.
The head of soldering iron cannot touch copper foil.